

## 20V N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SMC8810A is the Single N-Channel logic enhancement mode power field effect transistor which is produced using high cell density, advanced trench technology to provide excellent  $R_{DS(ON)}$ .

This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, and low in-line power loss are needed in small outline surface mount package. It is ESD protected.

*SMC8810AW-TRG ROHS Compliant This is Halogen Free*

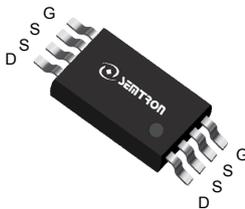
### FEATURE

- ◆ 20V/7.0A,  $R_{DS(ON)} = 14.5m\Omega (typ.) @ V_{GS} = 4.5V$
- ◆ 20V/7.0A,  $R_{DS(ON)} = 15m\Omega (typ.) @ V_{GS} = 4.0V$
- ◆ 20V/6.5A,  $R_{DS(ON)} = 16m\Omega (typ.) @ V_{GS} = 3.2V$
- ◆ 20V/5.5A,  $R_{DS(ON)} = 19m\Omega (typ.) @ V_{GS} = 2.5V$
- ◆ 20V/5.0A,  $R_{DS(ON)} = 26m\Omega (typ.) @ V_{GS} = 1.8V$
- ◆ ESD protection  $\pm 2KV$
- ◆ Super high density cell design for extremely low  $R_{DS(ON)}$
- ◆ Exceptional on-resistance and Maximum DC current capability

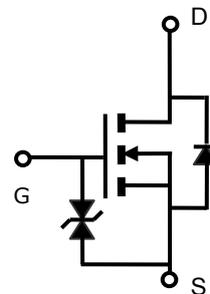
### APPLICATIONS

- ◆ Load Switch
- ◆ Portable Equipment
- ◆ Battery Powered System

### PIN CONFIGURATION



TSSOP-8  
Top View



### PART NUMBER INFORMATION

<p><b>SMC 8810A W - TR G</b></p> <p>a    b    c    d    e</p>	<p>a : Company name.  b : Product Serial number.  c : Package code  d : Handling code  e : Green produce code</p>
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## ORDERING INFORMATION

Part Number	Package Code	Handling Code	Shipping
SMC8810AW-TRG	W : TSSOP-8	TR : Tape&Reel	3K/Reel

- ※ Year Code : 0 ~ 9, 2010 : 0
- ※ Week Code : A(1~2) ~ Z(53~54)
- ※ TSSOP-8 : Only available in tape and reel packaging.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C Unless otherwise noted)

Symbol	Parameter	Typical	Unit
V <sub>DSS</sub>	Drain-Source Voltage	20	V
V <sub>GSS</sub>	Gate-Source Voltage	±12	V
I <sub>D</sub>	Continuous Drain Current (T <sub>C</sub> =25°C) <sup>A</sup>	V <sub>GS</sub> =4.5V	7.0
	Continuous Drain Current (T <sub>C</sub> =70°C)		5.8
I <sub>DM</sub>	Pulsed Drain Current <sup>B</sup>	30	A
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> =25°C	1.5
		T <sub>A</sub> =70°C	1.0
T <sub>J</sub>	Operation Junction Temperature	-55 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.  
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.

## THERMAL DATA

Symbol	Parameter	Typ	Max	Unit	
R <sub>θJA</sub>	Thermal Resistance-Junction to Ambient <sup>A</sup>	Steady-State	-	120	°C/W
R <sub>θJL</sub>	Thermal Resistance Junction to Lead <sup>A</sup>	Steady-State	-	75	°C/W

## ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C Unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Parameters</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	20			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA		0.75	1.0	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±8V			±10	μA
I <sub>DSS</sub>	Zero Gate Voltage, Drain-Source Leakage Current	V <sub>DS</sub> =16V, V <sub>GS</sub> =0V T <sub>J</sub> =25°C			1	μA
		V <sub>DS</sub> =16V, V <sub>GS</sub> =0V T <sub>J</sub> =75°C			5	
R <sub>DS(ON)</sub>	Drain-source On-Resistance <sup>B</sup>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =7.0A		14.5	20	mΩ
		V <sub>GS</sub> =4.0V, I <sub>D</sub> =7.0A		15	21	
		V <sub>GS</sub> =3.2V, I <sub>D</sub> =6.5A		16	22	
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =5.5A		19	24	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =5.0A		26	30	
G <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =6.5A		27		S
<b>Source-Drain Diode</b>						
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V		0.75	1.0	V
I <sub>S</sub>	Continuous Source Current <sup>AD</sup>				6.5	A
<b>Dynamic Parameters</b>						
Q <sub>g</sub> (4.5V)	Total Gate Charge	V <sub>DS</sub> =10V V <sub>GS</sub> =4.5V I <sub>D</sub> =7.0A		16		nC
Q <sub>gs</sub>	Gate-Source Charge			1.7		
Q <sub>gd</sub>	Gate-Drain Charge			6		
R <sub>g</sub>	Gate Resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz		1.2		Ω
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =10V V <sub>GS</sub> =0V f=1MHz		1120		pF
C <sub>oss</sub>	Output Capacitance			212		
C <sub>rss</sub>	Reverse Transfer Capacitance			198		
t <sub>d(on)</sub>	Turn-On Time	V <sub>DS</sub> =10V I <sub>D</sub> =7A		6.6	13.5	nS
t <sub>r</sub>				12	20	
t <sub>d(off)</sub>	Turn-Off Time	V <sub>GEN</sub> =4.5V R <sub>G</sub> =3.3Ω		63	115	
t <sub>f</sub>				30	58	

Note:

A. The value of R<sub>θJA</sub> is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T<sub>C</sub>=25°C.

B. The data tested by pulsed, pulse width ≤ 300μs, duty cycle ≤ 2%

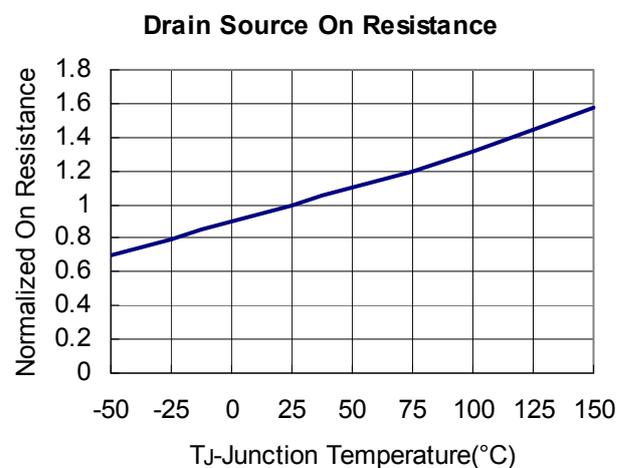
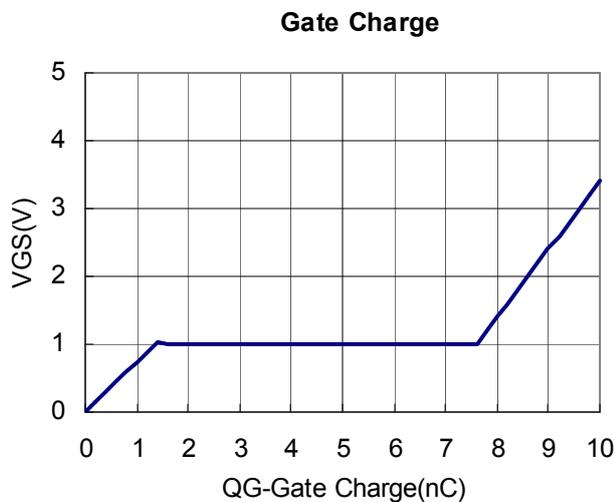
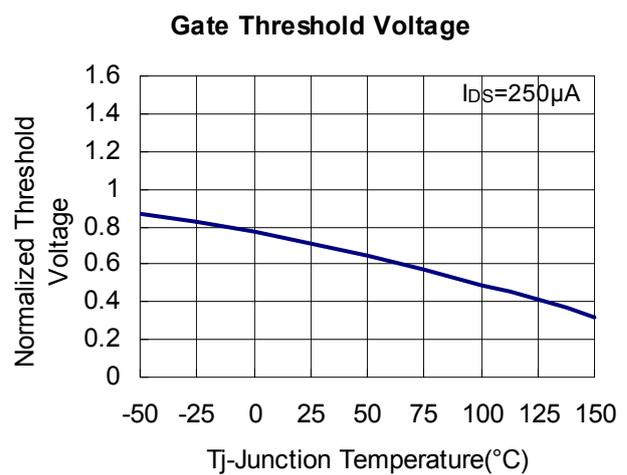
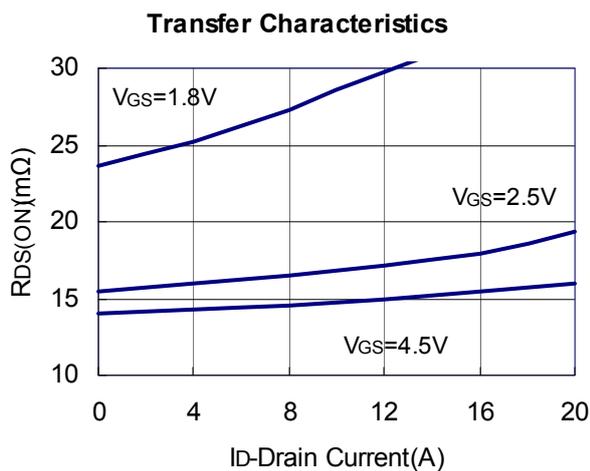
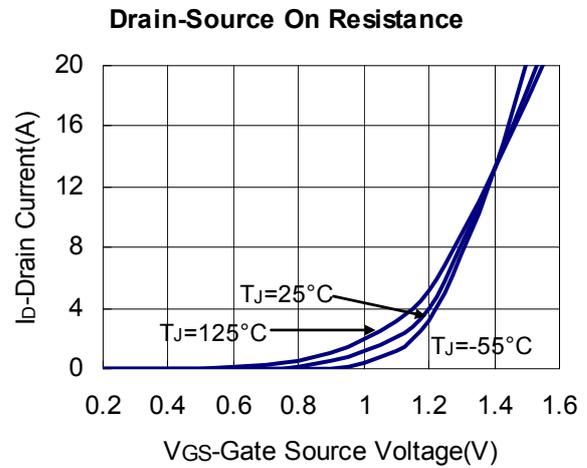
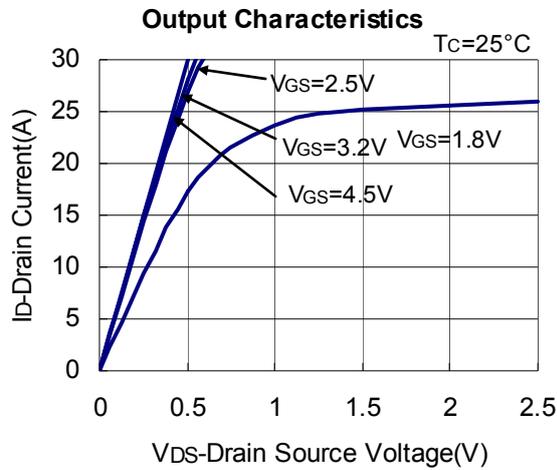
C. The EAS data shows Max. rating. The test condition is V<sub>DD</sub>=16V, V<sub>GS</sub>=4.5V, L=0.1mH.

D. The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub>, in real applications, should be limited by total power dissipation.

The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date

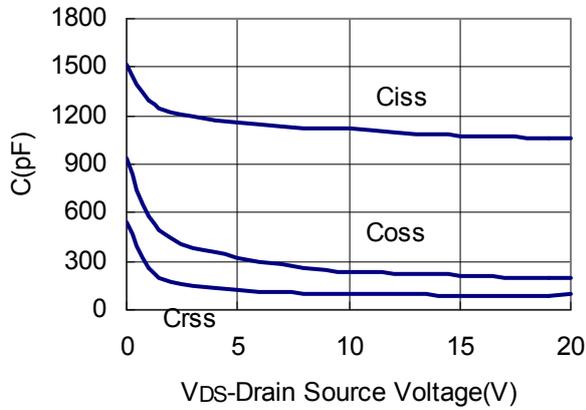
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## TYPICAL CHARACTERISTICS (25°C Unless Note)

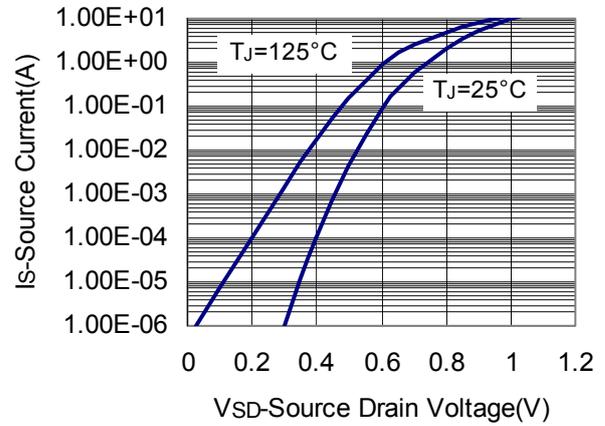


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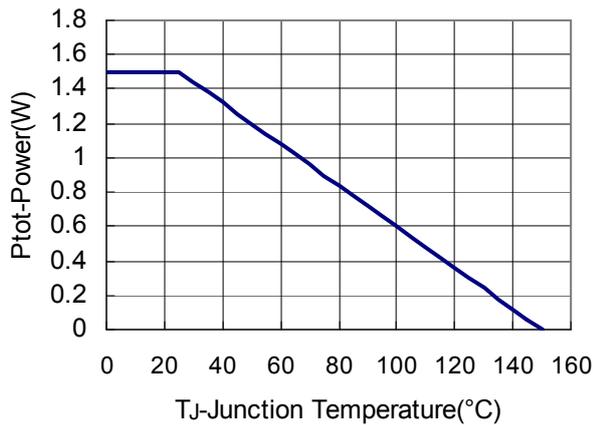
### Capacitance



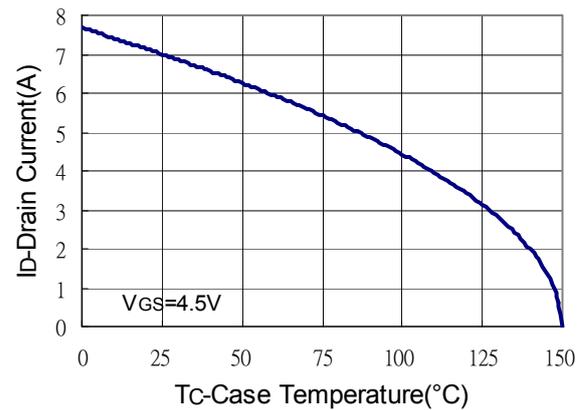
### Source Drain Diode Forward



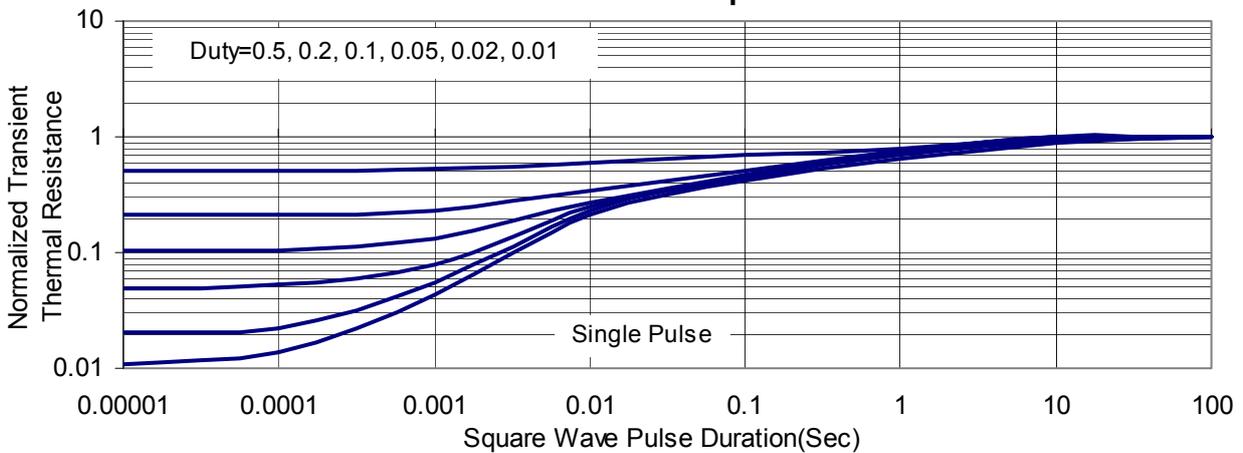
### Power Dissipation



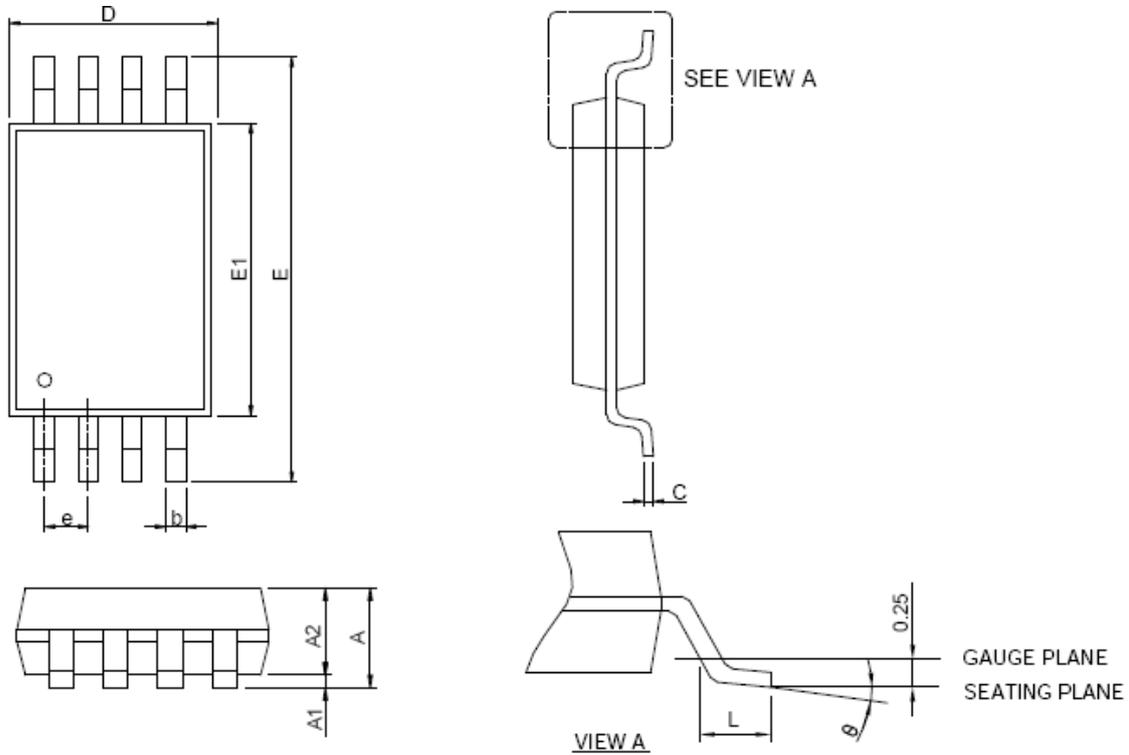
### Drain Current



### Thermal Transient Impedance



## TSSOP-8 PACKAGE DIMENSIONS



SYMBOL	TSSOP-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.20		0.047
A1	0.05	0.15	0.002	0.006
A2	0.80	1.05	0.031	0.041
b	0.19	0.30	0.007	0.012
c	0.09	0.20	0.004	0.008
D	2.90	3.10	0.114	0.122
E	6.20	6.60	0.244	0.260
E1	4.30	4.50	0.169	0.177
e	0.65 BSC		0.026 BSC	
L	0.45	0.75	0.018	0.030
$\theta$	0°	8°	0°	8°